## 502433001 07/25/2013

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Dong Hwan KIM	07/19/2013

### **RECEIVING PARTY DATA**

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City:	Incheon
State/Country:	REPUBLIC OF KOREA
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### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13981484

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Date:	07/25/2013

Total Attachments: 2

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<u>PATENT</u>

REEL: 030873 FRAME: 0331

# **ASSIGNMENT**

# FOR PRIORITY APPLICATION ENTERING UNITED STATES

######################################	
WHEREAS, I, KIM, Dong Hwan (hereina	fter referred to as ASSIGNOR), am the sole inventor of an
invention described in: - Korean Patent Application No. <u>10-2011</u>	0006777 51-1 747 2011
International application for Letters Patent	filed pursuant to the Patent Cooperation Treaty and designating
the United States, and being identified  November 23, 2011	by Application No. <u>PCT/KR2011/008961</u> , filed on
	oplication claiming priority from the above-
identified Korean and/or International pater	at application, the United States patent application being identifmark Office by Application No. 13/981,484,
liability company organized and existing under the laws 11 Hwasu-don, Dong-gu, Incheon 401-020 Republic of	TD. (hereinafter referred to as ASSIGNEE), a Korean Limited of the Republic of Korea, and having a place of business at 7-of Korea, is desirous of acquiring the entire right, title and and all Letters Patent(s) or similar legal protection, foreign or
acknowledged, I transfer to Assignee, its successors a invention, the above-identified application, all invent applications, all divisional, continuing, substitute, renewal have been or shall be filed in the United States on any resulting from the filing of the above-identified patent applications.	consideration, the receipt and adequacy of which is hereby nd assigns, my entire right, title and interest in and to the tions and improvements which are disclosed in the patent t, reissue, and all other applications for Letters Patent(s) which of said inventions and/or improvements, all rights of priority oplication(s), and all Letters Patent or similar legal protection ted States Patent and Trademark Office to issue the Letters
I authorize the Assignee, its successors and as number of the application when ascertained.	ssigns, to insert in this instrument the filing date and serial
I authorize the Assignee, its successors and a Letters Patent or similar legal protection, in its own name	assigns, or anyone it may properly designate, to apply for a if desired, in any and all countries.
do any act whatsoever conflicting with this Assignment request, without additional consideration, but at the exper additional writings and do such additional acts as the A	assigns, that I have not and shall not execute any writing or t. I, my executors or administrators, will at any time upon use of the Assignee, its successors and assigns, execute such assignee, its successors and assigns, may deem desirable to ance in making application for and obtaining, maintaining, n on the invention in any and all countries.
Kim Dong Hwan	1
Signature of Inventor	Signature of Witness
Date: July, 19, 2013	Date: July 10, 2013
KIM, Dong Hwan	CHO, Yoon Hee
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-2 of 2-

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PATENT REEL: 030873 FRAME: 0333